

1.1 Scope.

This specification covers the detail requirements for a high precision 5 volt IC reference.

1.2 Part Number.

The complete part number per Table 1 of this specification is as follows:

Device	Part Number
-1	AD586SQ/883B
-2	AD586TQ/883B

1.2.3 Case Outline.

See Appendix I of General Specification ADI-M-1000: package outline: Q-8A.

1.3 Absolute Maximum Ratings. ($T_A = +25^\circ\text{C}$ unless otherwise noted)

Input Voltage V_{IN} to Ground	+ 36V
Power Dissipation	500mW
Storage Temperature Range	- 65°C to + 150°C
Lead Temperature (Soldering 10secs)	+ 300°C

1.5 Thermal Characteristics.

Thermal Resistance $\theta_{JC} = 22^\circ\text{C/W}$
 $\theta_{JA} = 110^\circ\text{C/W}$

AD586—SPECIFICATIONS

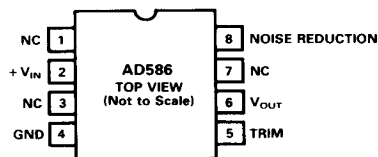
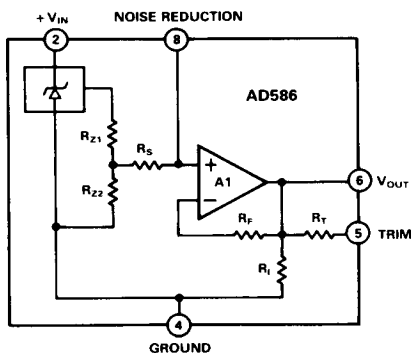
Table 1.

Test	Symbol	Device	Design Limit @ +25°C	Sub Group 1	Sub Group 2, 3	Sub Group 4	Test Condition ¹	Units
Quiescent Current	I _{CC}	-1, 2	3	3				+ mA max
Output Voltage Error	V _{OUT}	-1	10	10				± mV max
		-2	2.5	10		2.5		
Gain Adjustment	V _{ADJ}	-1, 2	+ 300 - 100	+ 300 - 100				mV min
Line Regulation	VR _{LINE}	-1, 2	150	150	150		11.4V ≤ V _{IN} ≤ 36V	± μV/V max
Load Regulation, Sourcing	VR _{LOAD}	-1, 2	150	150	150		I _L = 0 to 10mA	± μV/mA max
Load Regulation, Sinking	I _{OUT}	-1, 2	400	400			I _L = -10 to 0mA	± μV/mA max
Output Voltage Temperature Coefficient	DV _{OUT} /dT	-1	20		20		T _A = -55°C to +125°C	± ppm/°C max
		-2	10		10			
Output Short-Circuit Current	I _{OS}	-1	50	50			To Ground	+ mA max

NOTE

¹T_A = +25°C; V_{CC} = +15V unless otherwise stated.

3.2.1 Functional Block Diagram and Terminal Assignments.

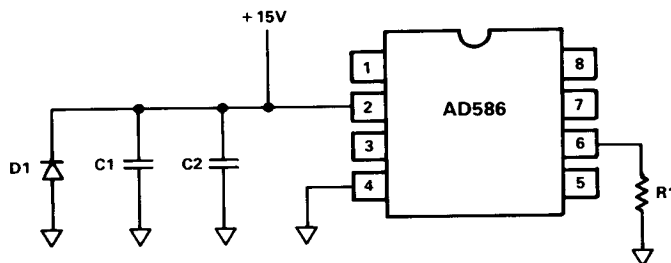


3.2.4 Microcircuit Technology Group.

This microcircuit is covered by technology group (59).

4.2.1 Life Test/Burn-In Circuit.

Steady state life test is per MIL-STD-883 Method 1005. Burn-in is per MIL-STD-883 Method 1015 test condition (B).



NOTE: D1 = MR-820
C1 = 0.1 μ F
C2 = 47 μ F
R1 = 500 Ω 1/2 WATT AT 25°C